imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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SPECIFICATION

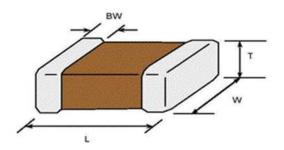
(Reference sheet)

- · Supplier : Samsung electro-mechanics
- · Product : Multi-layer Ceramic Capacitor
- Samsung P/N :
 Description :
- CL31C5R6DBCNNNC CAP, 5.6pF, 50V, ± 0.5pF, C0G, 1206

A. Samsung Part Number

| | | - | <u>CL</u> <u>31</u> ① ② | <u>C</u> ③ | <u>5R6</u> ④ | <u>D</u> (5) | <u>B</u> 6 | <u>C</u> ⑦ | <u>N</u> 8 | <u>N</u> 9 | <u>N</u> 10 | <u>C</u> 11 | |
|-------------|---|---------------------------|----------------------------|---------------|-----------------|-----------------|--------------------------|---------------|---------------|---------------|----------------|--|-----------|
| - | Series Size | Samsung Mult 1206 (inc | ti-layer Ce ch code) | rami | | | ± 0.15 | mm | | | W: | 1.60 ± 0.15 mm | |
| 3 4 5 | Capacitance | C0G 5.6 pF ± 0.5pF | | | | 8 | Inner Termi Platin | natio g | | | | Ni Cu Sn 100% | (Pb Free) |
| 6 7 | tolerance Rated Voltage Thickness | 50 V 0.85 ± 0.15 m | m | | | 9 10 11 | Produ Speci Packa | al | | | | Normal Reserved for fut Cardboard Type | |

B. Structure and dimension



| Samsung P/N | Dimension(mm) | | | | | | | |
|-----------------|---------------|-------------|-------------|-------------|--|--|--|--|
| (Lead Free) | L | W | Т | BW | | | | |
| CL31C5R6DBCNNNC | 3.20 ± 0.15 | 1.60 ± 0.15 | 0.85 ± 0.15 | 0.50 ± 0.30 | | | | |

C. Samsung Reliability Test and Judgement condition

| | Performance | Test condition | | | | |
|-------------------|---|--|--|--|--|--|
| Capacitance | Within specified tolerance | 1 [™] ±10% / 0.5~5Vrms | | | | |
| Q | 512 min | | | | | |
| Insulation | 10,000Mohm or 500Mohm× <i>μ</i> F | Rated Voltage 60~120 sec. | | | | |
| Resistance | Whichever is smaller | | | | | |
| Appearance | No abnormal exterior appearance | Microscop (X10) | | | | |
| Withstanding | No dielectric breakdown or | 300% of the rated voltage | | | | |
| Voltage | mechanical breakdown | | | | | |
| Temperature | C0G | | | | | |
| Characteristics | (From -55℃ to 125℃, Capacitance change s | should be within ±30PPM/ິC) | | | | |
| Adhesive Strength | No peeling shall be occur on the | 500g×F, for 10±1 sec. | | | | |
| of Termination | terminal electrode | | | | | |
| Bending Strength | Capacitance change : | Bending to the limit (1mm) | | | | |
| | within $\pm 5\%$ or ± 0.5 pF whichever is larger | with 1.0mm/sec. | | | | |
| Solderability | More than 75% of terminal surface | SnAg3.0Cu0.5 solder | | | | |
| | is to be soldered newly | 245±5℃, 3±0.3sec. | | | | |
| | | (preheating : 80~120 ℃ for 10~30sec.) | | | | |
| | | | | | | |
| Resistance to | Capacitance change : | Solder pot : 270±5℃, 10±1sec. | | | | |
| Soldering heat | within $\pm 2.5\%$ or $\pm 0.25 \text{ pF}$ whichever is larger | | | | | |
| | Tan δ, IR : initial spec. | | | | | |
| Vibration Test | Capacitance change : | Amplitude : 1.5mm | | | | |
| | within $\pm 2.5\%$ or $\pm 0.25 \text{ pF}$ whichever is larger | From 10Hz to 55Hz (return : 1min.) | | | | |
| | Tan δ, IR : initial spec. | 2hours ´ 3 direction (x, y, z) | | | | |
| Moisture | Capacitance change : | With rated voltage | | | | |
| Resistance | within ±7.5% or ±0.75pF whichever is larger | 40±2℃, 90~95%RH, 500+12/-0hrs | | | | |
| | Q: 118.67 min | | | | | |
| | IR : 500Mohm or 25Mohm × μF | | | | | |
| | Whichever is smaller | | | | | |
| High Temperature | Capacitance change : | With 200% of the rated voltage | | | | |
| Resistance | within $\pm 3\%$ or ± 0.3 pF whichever is larger | Max. operating temperature | | | | |
| | Q: 256 min | 1000+48/-0hrs | | | | |
| | IR : 1,000Mohm or 50Mohm × μF | | | | | |
| | Whichever is smaller | | | | | |
| Temperature | Capacitance change : | 1 cycle condition | | | | |
| Cycling | within $\pm 2.5\%$ or ± 0.25 pF whichever is larger | Min. operating temperature $\rightarrow 25^{\circ}$ C | | | | |
| J - 3 | Tan δ , IR : initial spec. | \rightarrow Max. operating temperature \rightarrow 25 °C | | | | |
| | | | | | | |
| | | | | | | |
| | | 5 cycle test | | | | |

* The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 °C, 10sec. Max)

Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time. So, you need to approve the product specifications before placing an order. Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.

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- Aerospace/Aviation equipment
- 2 Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- ④ Military equipment
- *⑤* Disaster prevention/crime prevention equipment
- *ⓐ* Any other applications with the same as or similar complexity or reliability to the applications set forth above.